



Product Change Notification

Change Notification #: 117752 - 00

Change Title: Intel® Mezzanine Fabric Carrier KitAWF1PFABKITM, Intel® PCIe Add-In Fabric Carrier Kit AWF1PFABKITP, Intel® Spare Cable Kit - 235 mm AXXCBL235IFPL1, Intel® Spare Cable Kit - 235 mm AXXCBL235IFPR1, Intel® Accessory Cable Kit - 370 mm AXXCBL370IFPS1, Intel® Spare Cable 430 mm AXXCBL430IFTSBY, PCN 117752-00, Product Discontinuance, End of Life

Date of Publication: August 25, 2020

Key Characteristics of the Change:

Product Discontinuance

Forecasted Key Milestones:

Product Discontinuance Program Support Begins:	September 1, 2020
Last Product Discontinuance Order Date:	November 1, 2020
Orders are Non-Cancelable and Non-Returnable After:	December 1, 2020
Last Product Discontinuance Shipment Date:	January 1, 2021

Description of Change to the Customer:

Intel is announcing the discontinuance of spare parts listed in the "Products Affected/Intel Ordering Codes" table below.

Intel will make commercially reasonable efforts to support all orders placed between the Non-Cancelable and Non-Returnable (NCNR) and the Last Product Discontinuance Order (LPDO) dates. Intel will discontinue builds on the LPDO date. After the LPDO date existing inventory is still orderable, under NCNR terms, and will be filled as Intel considers appropriate. Deliveries must be accepted within 90 days from the LPDO date.

Final purchase orders are non-cancelable and non-returnable, notwithstanding any conflicting terms in our quotes, purchase order acknowledgement or Distributor agreements.

Intel reserves the right to change the products because of material source restriction.

Engineering and Support Guidance for Discontinued Products:

No new OS, peripheral or adaptor validation is planned during the extended life period. The THOL, supported processor and tested memory lists are frozen at PDA.

No new features enhancements should be expected, however ECOs may be required during the extended life period to maintain supply lines (e.g. to qualify new vendor due to a component EOL).

Intel will provide reasonable commercial efforts in debugging issues during the warranty period for the product after the PDA date has passed. Fixes cannot be committed, but Intel will endeavor to provide reasonable workarounds for the product.

Customer Impact of Change and Recommended Action:

Determine your remaining demand for this product and/or evaluate additional sources (if applicable).

Lead-times on products with announced product discontinuance can typically stretch to 12 weeks and volumes are not buffered during the PDA period. Please work with your Intel representative on your quarterly demand forecast in order to reduce lead-times to 2-4 Weeks.

Please contact your local Intel Sales Office or Distributor if you require more information or need assistance in selecting a replacement product.

Milestone dates are estimates and subject to change based on business and operational conditions.

Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	MM#
Intel® Mezzanine Fabric Carrier Kit	AWF1PFABKITP	955859
Intel® PCIe Add-in Fabric Carrier Kit	AWF1PFABKITM	955873
Intel® Spare Cable Kit – 235 mm	AXXCBL235IFPR1	958250
Intel® Spare Cable Kit – 235 mm	AXXCBL370IFPS1	958251
Intel® Accessory Cable Kit - 370 mm	AXXCBL235IFPL1	958252
Intel® Spare Cable 430 mm	AXXCBL430IFTSBY	958253

PCN Revision History:

Date of Revision:

August 25, 2020

Revision Number:

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Reason:

Originally Published PCN



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The products described in this document may contain design defects or errors known as errata which may cause the product to deviate from published specifications. Current characterized errata are available on request.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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